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| SERIAL NUMBER 10/690,782 | FILING OR 371(c) DATE 10/21/2003 RULE | CLASS 257 | GROUP ART UNIT 2822 | ATTORNEY DOCKET NO. 9903-071 |
| APPLICANTS Jin-Hyuk Lee, Kyungki-Do, KOREA, REPUBLIC OF; Gu-Sung Kim, Kyungki-do, KOREA, REPUBLIC OF; Dong-Ho Lee, Kyungki-do, KOREA, REPUBLIC OF; Dong-Hyeon Jang, Seoul, KOREA, REPUBLIC OF; | | | | |
| ** CONTINUING DATA ***** <i>NONE</i> | | | | |
| ** FOREIGN APPLICATIONS ***** REPUBLIC OF KOREA 2002-64513 10/22/2002 | | | | |
| IF REQUIRED, FOREIGN FILING LICENSE GRANTED ** 01/20/2004 | | | | |
| Foreign Priority claimed <input checked="" type="checkbox"/> yes <input type="checkbox"/> no 35 USC 119 (a-d) conditions met <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after Allowance Verified and Acknowledged | Examiner's Signature <i>[Signature]</i> Initials <i>[Initials]</i> | STATE OR COUNTRY KOREA, REPUBLIC OF | SHEETS DRAWING 10 | TOTAL CLAIMS 17 |
| INDEPENDENT CLAIMS 3 | | | | |
| ADDRESS 20575 | | | | |
| TITLE Method for manufacturing a wafer level chip scale package | | | | |
| FILING FEE RECEIVED 970 | FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT No. _____ for following: | | <input type="checkbox"/> All Fees <input type="checkbox"/> 1.16 Fees (Filing) <input type="checkbox"/> 1.17 Fees (Processing Ext. of time) <input type="checkbox"/> 1.18 Fees (Issue) <input type="checkbox"/> Other _____ <input type="checkbox"/> Credit | |